**Product data sheet** 

## 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Logic-level compatible
- Trench MOSFET technology
- Ultra low Q<sub>G</sub> and Q<sub>GD</sub> for high system efficiency, especially at higher switching frequencies
- Superfast switching with soft-recovery
- · Low spiking and ringing for low EMI designs
- MLPAK33 package (3.3 x 3.3 mm footprint)

## 3. Applications

- DC to DC conversion
- · Battery management
- · Low-side load switch
- Switching circuits

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	30	V
$V_{GS}$	gate-source voltage			-20	-	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-	16.5	Α
Static charac	teristics		·			·	
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 10.3 A; T <sub>j</sub> = 25 °C		-	8.7	10.2	mΩ
		$V_{GS}$ = 4.5 V; $I_D$ = 8.9 A; $T_j$ = 25 °C		-	10.8	13.6	mΩ
Dynamic cha	racteristics		•		'	'	
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = 15 V; $I_{D}$ = 8.9 A; $V_{GS}$ = 4.5 V; $T_{j}$ = 25 °C		-	4	6	nC

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



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# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	1 2 3 4	D
2	S	source		
3	S	source		G (F)
4	G	gate	l h d	mbb076 S
5	D	drain		
6	D	drain		
7	D	drain	MLPAK33 (SOT8002-1)	
8	D	drain		

## 6. Ordering information

### **Table 3. Ordering information**

Type number	Package						
	Name	Description	Version				
PXN010-30QL		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1				

## 7. Marking

### **Table 4. Marking codes**

Type number	Marking code
PXN010-30QL	9AC

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## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	30	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	10.3	Α
		V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 100 °C	[1]	-	6.5	Α
		V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	16.5	Α
		V <sub>GS</sub> = 10 V; T <sub>sp</sub> = 25 °C		-	28	Α
I <sub>DM</sub>	peak drain current	T <sub>amb</sub> = 25 °C; single pulse; t <sub>p</sub> ≤ 10 μs		-	264	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[1]	-	1.7	W
		T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	4.3	W
		T <sub>sp</sub> = 25 °C		-	12.5	W
T <sub>j</sub>	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-draii	n diode		'		'	
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	1.5	Α
Avalanche r	uggedness		'	1		
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	T <sub>j(init)</sub> = 25 °C; I <sub>D</sub> = 1.2 A; DUT in valanche (unclamped)		-	18	mJ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

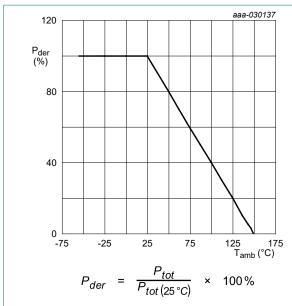


Fig. 1. Normalized total power dissipation as a function of ambient temperature

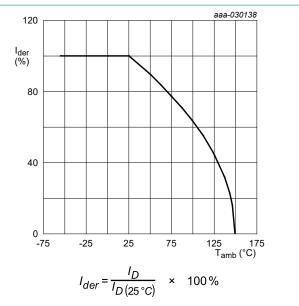


Fig. 2. Normalized continous drain current as a function of ambient temperature

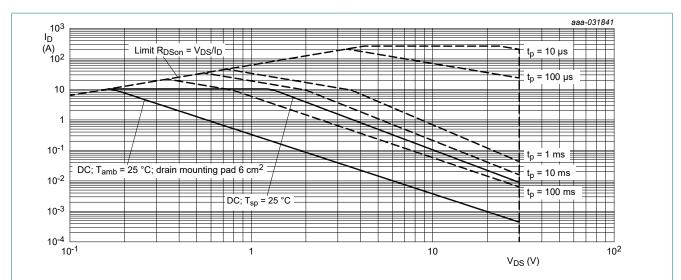


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

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## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1]	-	150	190	K/W
	junction to ambient		[2]	-	60	75	K/W
		in free air; t ≤ 5 s	[2]	-	24	29	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	7	10	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

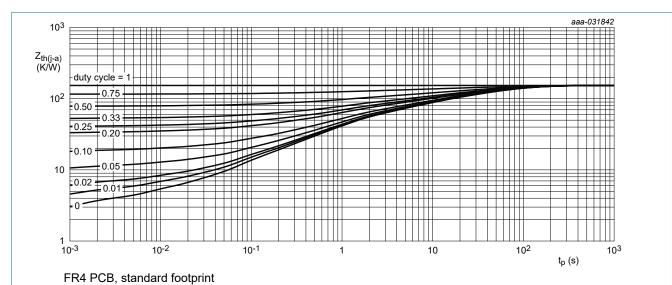


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

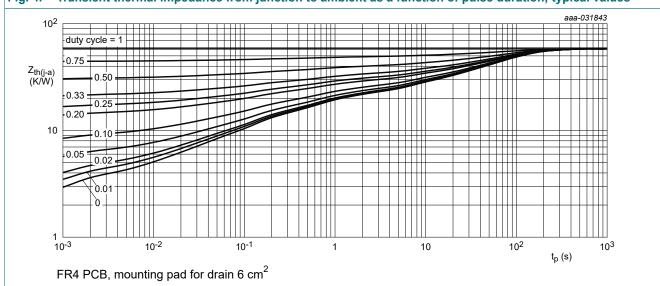


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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## 10. Characteristics

### **Table 7. Characteristics**

5 °C 5 °C 5 °C 5 °C 5 °C 5 °C	30 1.2 - -	1.7	- 2.2 1 100	V V µA nA
5 °C 5 °C 5 °C 5 °C 5 °C	1.2	-	1	V μΑ
5 °C 5 °C 5 °C 5 °C	-	-	1	μΑ
5 °C 5 °C 5 °C	-	-		
5 °C 5 °C	-	-	100	nΔ
5 °C	-	-		11/
	-		-100	nA
50 °C		8.7	10.2	mΩ
	-	13.5	15.8	mΩ
5 °C	-	10.8	13.6	mΩ
5 °C	-	24	-	S
	-	3	-	Ω
,				
: 10 V;	-	8.2	12.3	nC
4.5 V;	-	4	6	nC
	-	1.5	-	nC
	-	0.9	-	nC
	-	0.6	-	nC
	-	1.1	-	nC
°C	-	2.8	-	V
0 V;	-	580	-	pF
	-	230	-	pF
	-	33	-	pF
4.5 V;	-	5	-	ns
	-	8	-	ns
	-	6	-	ns
	-	3	-	ns
1		1		
C	-	0.7	1.2	V
	-	15	-	ns
25 °C	-	6	-	nC
	-	8	-	ns
	-	7	-	ns
	5 °C		25 °C	- 24 - 3 - 3

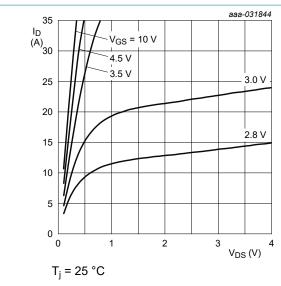


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

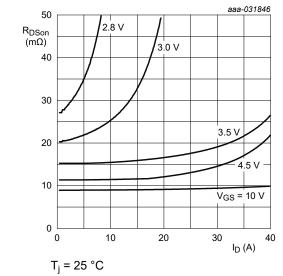


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

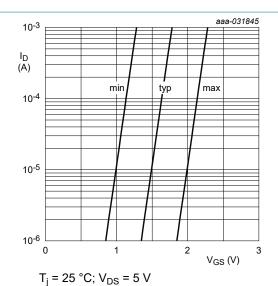


Fig. 7. Subthreshold drain current as a function of gate-source voltage

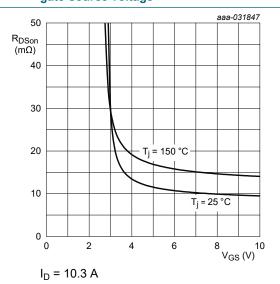


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

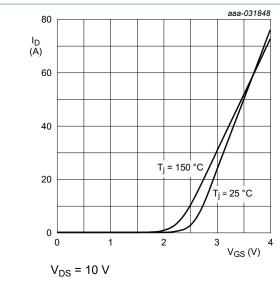


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

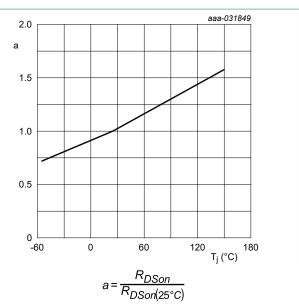


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

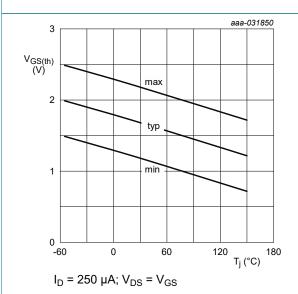


Fig. 12. Gate-source threshold voltage as a function of junction temperature

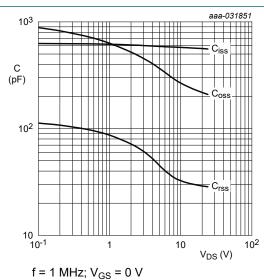


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

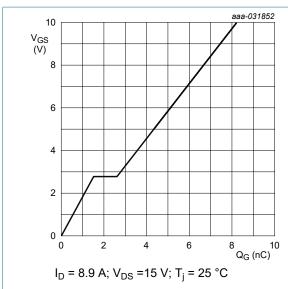


Fig. 14. Gate-source voltage as a function of gate charge; typical values

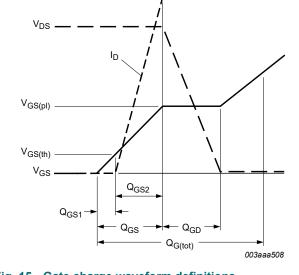


Fig. 15. Gate charge waveform definitions

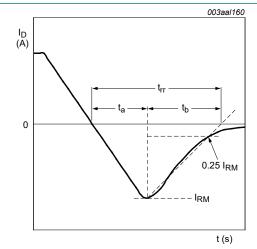


Fig. 16. Reverse recovery timing definition

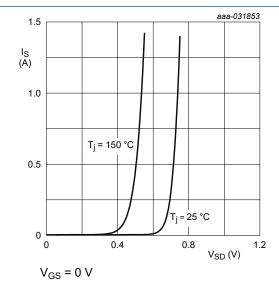
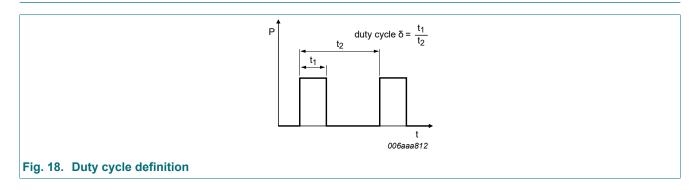


Fig. 17. Source current as a function of source-drain voltage; typical values

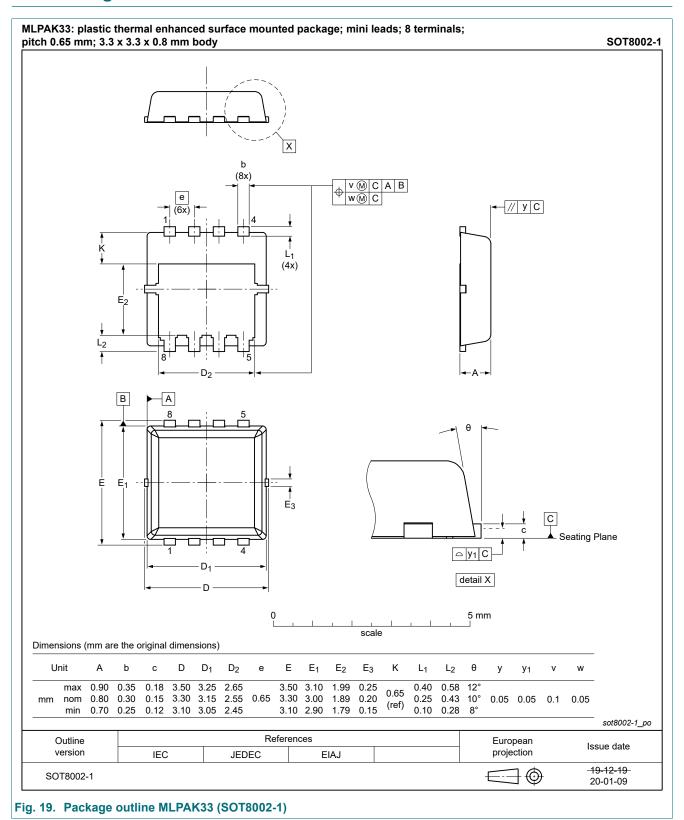
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## 11. Test information



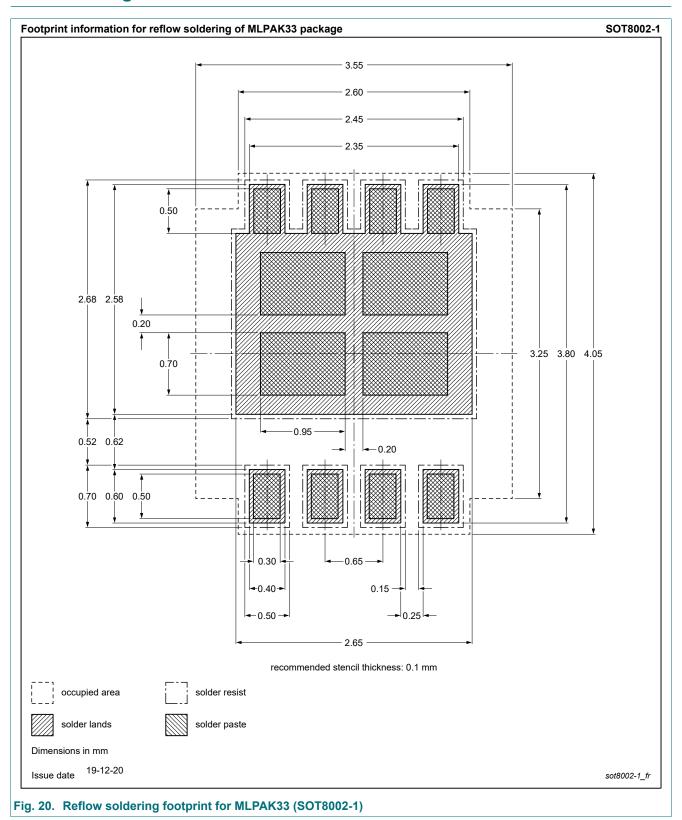
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## 12. Package outline



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## 13. Soldering



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# 14. Revision history

### Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PXN010-30QL v.1	20201102	Product data sheet	-	-

#### 30 V, N-channel Trench MOSFET

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### 30 V, N-channel Trench MOSFET

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